MOSFET – N-Channel, QFET[®]

100 V, 48 A, 39 m Ω

FQH44N10

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

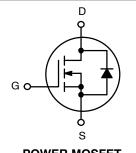
- 48 A, 100 V, $R_{DS(on)} = 39 \text{ m}\Omega \text{ (Max.)} @ V_{GS} = 10 \text{ V},$ $I_D = 24 \text{ A}$
- Low Gate Charge (Typ. 48 nC)
- Low Crss (Typ. 85 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating



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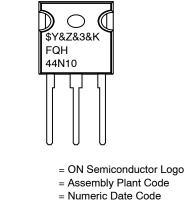
V _{DSS}	R _{DS(ON)} MAX	I _D MAX
100 V	$39~\mathrm{m}\Omega$ @ 10 V	48 A



POWER MOSFET



MARKING DIAGRAM



\$Y

&Z

&3

&K

FQH44N10

- = Lot Code
- = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Par	FQH44N10-133	Unit	
V _{DSS}	Drain-Source Voltage	100	V	
I _D	Drain Current	Continuous (T _C = 25°C)	48	А
		Continuous (T _C = 100°C)	34	
I _{DM}	Drain Current	Pulsed (Note 1)	192	А
V _{GSS}	Gate-Source Voltage	te-Source Voltage		V
E _{AS}	Single Pulsed Avalanche Energy (Note 2) Avalanche Current (Note 1)		530	mJ
I _{AR}			48	А
E _{AR}	Repetitive Avalanche Energy (Note 1	18	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns
PD	Power Dissipation	(T _C = 25°C)	180	W
		Derate Above 25°C	1.2	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to +175	°C
ΤL	Maximum Lead Temperature for Sold 1/8" from Case for 5 seconds	300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. L = 0.345 mH, I_{AS} = 48 A, V_{DD} = 25 V, R_G = 25 Ω , starting T_J = 25°C. 3. I_{SD} ≤ 43.5 A, di/dt ≤ 300 A/µs, V_{DD} ≤ BV_{DSS}, starting T_J = 25°C.

THERMAL CHARACTERISTICS

Symbol	Parameter	FQH44N10-133	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.83	°C/W	
R _{0CS}	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W	
R _{θJA}	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQH44N10-133	FQH44N10	TO-247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS	•			•	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \ \mu\text{A}$	100			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		0.1		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ
		$V_{DS} = 80 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$			10	
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 24 A		0.03	0.039	Ω
9 FS	Forward Transconductance	V _{DS} = 40 V, I _D = 24 A		31		S
YNAMIC CHA	RACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1.0 \text{ MHz}$		1400	1800	pF
C _{oss}	Output Capacitance			425	550	pF
C _{rss}	Reverse Transfer Capacitance			85	110	pF
WITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 43.5 \text{ A}, \text{ R}_{g} = 25 \Omega$		19	45	ns
t _r	Turn-On Rise Time	(Note 4)		190	390	ns
t _{d(off)}	Turn-Off Delay Time			90	190	ns
t _f	Turn-Off Fall Time			100	210	ns
Qg	Total Gate Charge	$V_{DS} = 80 \text{ V}, \text{ I}_{D} = 43.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$		48	62	nC
Q _{gs}	Gate-Source Charge	(Note 4)		9.0		nC
Q _{gd}	Gate-Drain Charge]		24		nC
RAIN-SOURC	E DIODE CHARACTERISTICS AND MA	XIMUM RATINGS				
۱ _S	Maximum Continuous Drain-Source Diode Forward Current				48	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	orward Current		1	192	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 48A$			1.5	V

 Q_{rr}
 Reverse Recovery Charge
 dir/dir
 100 / yith
 360
 nC

 Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
 360
 nC

 $\begin{array}{l} V_{GS}=~0~V,~I_{S}=~43.5~A,\\ dI_{F}/dt=100~A/\mu s \end{array}$

98

ns

4. Essentially independent of operating temperature typical characteristics.

Reverse Recovery Time

t_{rr}

TYPICAL PERFORMANCE CHARACTERISTICS

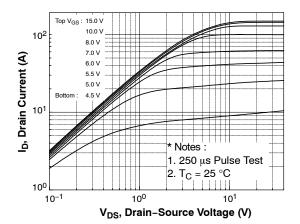


Figure 1. On-Region Characteristics

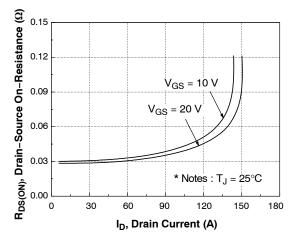


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

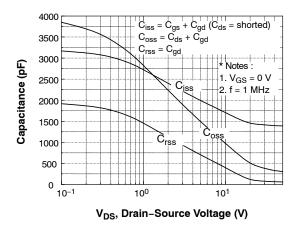


Figure 5. Capacitance Characteristics

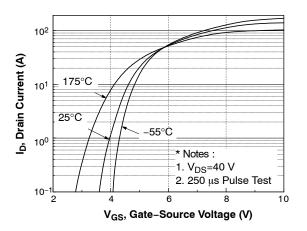


Figure 2. Transfer Characteristics

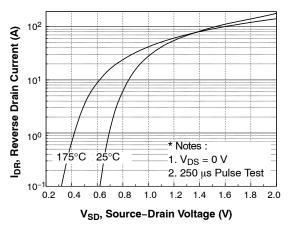


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

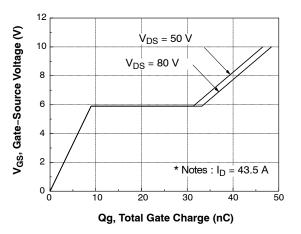


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

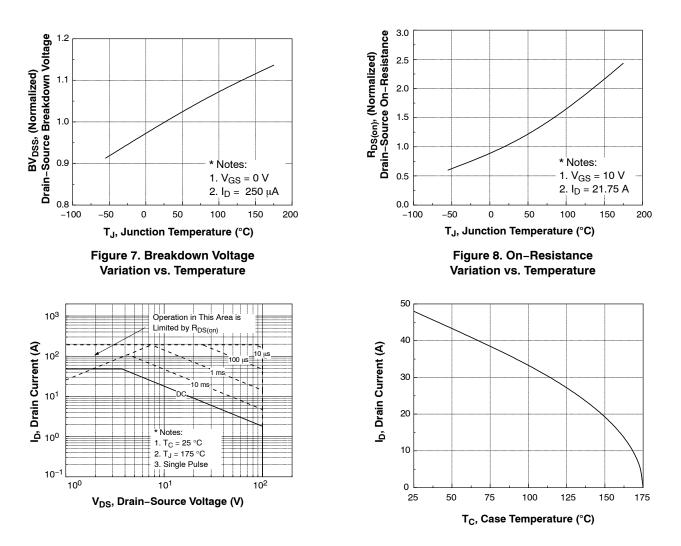
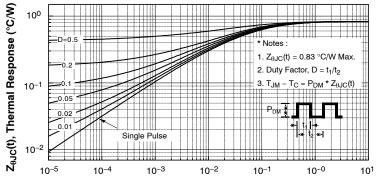


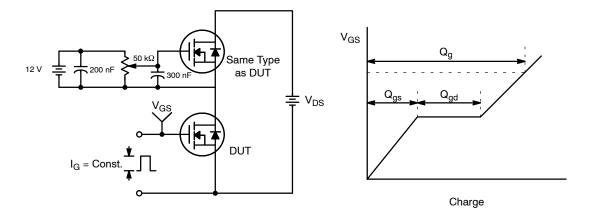
Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature



t1, Square Wave Pulse Duration (sec)

Figure 11. Transient Thermal Response Curve





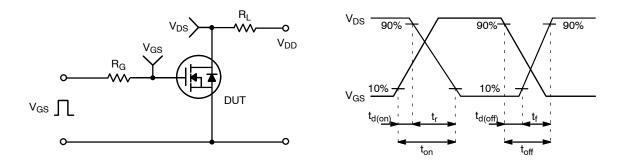


Figure 13. Resistive Switching Test Circuit & Waveforms

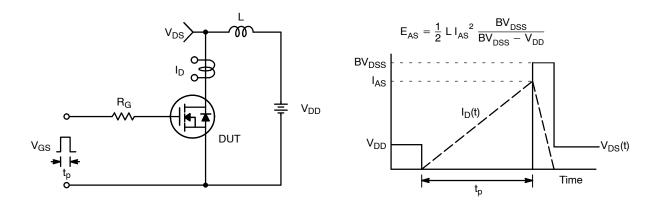


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

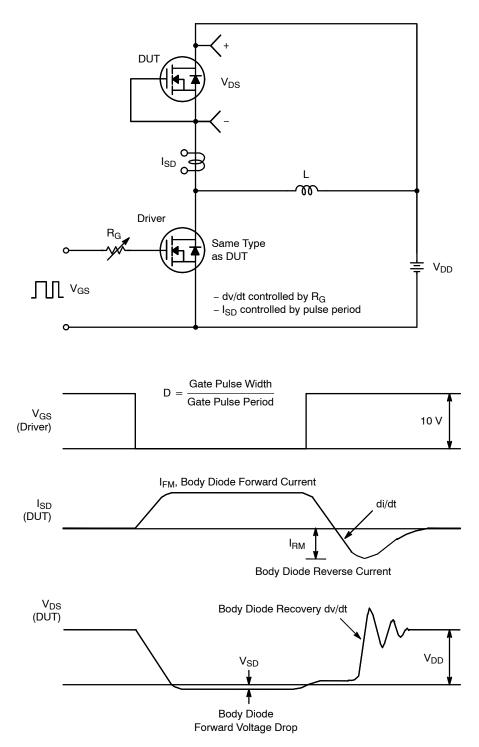


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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